



CYPRESS

CY7C1049B

512K x 8 Static RAM

Features

- **High speed**
— $t_{AA} = 12 \text{ ns}$
- **Low active power**
— 1320 mW (max.)
- **Low CMOS standby power (Commercial L version)**
— 2.75 mW (max.)
- **2.0V Data Retention (400 μW at 2.0V retention)**
- **Automatic power-down when deselected**
- **TTL-compatible inputs and outputs**
- **Easy memory expansion with $\overline{\text{CE}}$ and $\overline{\text{OE}}$ features**

Functional Description

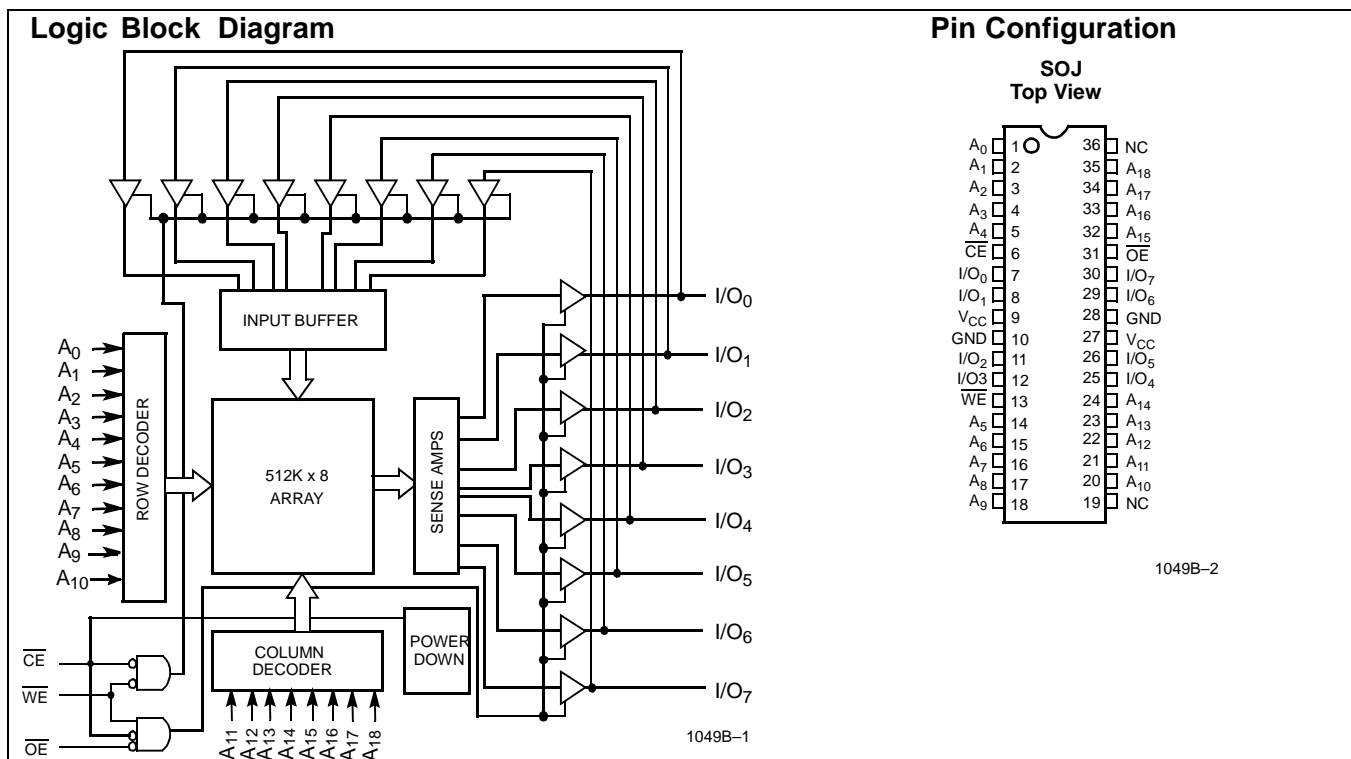
The CY7C1049B is a high-performance CMOS static RAM organized as 524,288 words by 8 bits. Easy memory expansion

is provided by an active LOW Chip Enable ($\overline{\text{CE}}$), an active LOW Output Enable ($\overline{\text{OE}}$), and three-state drivers. Writing to the device is accomplished by taking Chip Enable ($\overline{\text{CE}}$) and Write Enable ($\overline{\text{WE}}$) inputs LOW. Data on the eight I/O pins (I/O_0 through I/O_7) is then written into the location specified on the address pins (A_0 through A_{18}).

Reading from the device is accomplished by taking Chip Enable ($\overline{\text{CE}}$) and Output Enable ($\overline{\text{OE}}$) LOW while forcing Write Enable ($\overline{\text{WE}}$) HIGH. Under these conditions, the contents of the memory location specified by the address pins will appear on the I/O pins.

The eight input/output pins (I/O_0 through I/O_7) are placed in a high-impedance state when the device is deselected ($\overline{\text{CE}}$ HIGH), the outputs are disabled ($\overline{\text{OE}}$ HIGH), or during a write operation ($\overline{\text{CE}}$ LOW, and $\overline{\text{WE}}$ LOW).

The CY7C1049B is available in a standard 400-mil-wide 36-pin SOJ package with center power and ground (revolutionary) pinout.



Selection Guide

	7C1049B-12	7C1049B-15	7C1049B-17	7C1049B-20	7C1049B-25
Maximum Access Time (ns)	12	15	17	20	25
Maximum Operating Current (mA)	240	220	195	185	180
Maximum CMOS Standby Current (mA)	Com'l	8	8	8	8
	Com'l/Ind'l L	-	-	0.5	0.5
	Ind'l	-	-	9	9

Maximum Ratings

(Above which the useful life may be impaired. For user guidelines, not tested.)

Storage Temperature -65°C to +150°C

Ambient Temperature with
Power Applied..... -55°C to +125°C

Supply Voltage on V_{CC} to Relative GND^[1] -0.5V to +7.0V

DC Voltage Applied to Outputs
in High Z State^[1] -0.5V to $V_{CC} + 0.5V$

DC Input Voltage^[1] -0.5V to $V_{CC} + 0.5V$

Current into Outputs (LOW) 20 mA

Static Discharge Voltage >2001V
(per MIL-STD-883, Method 3015)

Latch-Up Current..... >200 mA

Operating Range

Range	Ambient Temperature ^[2]	V_{CC}
Commercial	0°C to +70°C	4.5V–5.5V
Industrial	-40°C to +85°C	

Electrical Characteristics Over the Operating Range

Parameter	Description	Test Conditions	7C1049B-12		7C1049B-15		7C1049B-17		Unit	
			Min.	Max.	Min.	Max.	Min.	Max.		
V _{OH}	Output HIGH Voltage	V _{CC} = Min., I _{OH} = −4.0 mA	2.4		2.4		2.4		V	
V _{OL}	Output LOW Voltage	V _{CC} = Min., I _{OL} = 8.0 mA		0.4		0.4		0.4	V	
V _{IH}	Input HIGH Voltage		2.2	V _{CC} + 0.3	2.2	V _{CC} + 0.3	2.2	V _{CC} + 0.3	V	
V _{IL}	Input LOW Voltage ^[1]		−0.3	0.8	−0.3	0.8	−0.3	0.3	V	
I _{IX}	Input Load Current	GND ≤ V _I ≤ V _{CC}	−1	+1	−1	+1	−1	+1	μA	
I _{OZ}	Output Leakage Current	GND ≤ V _{OUT} ≤ V _{CC} , Output Disabled	−1	+1	−1	+1	−1	+1	μA	
I _{CC}	V _{CC} Operating Supply Current	V _{CC} = Max. f = f _{MAX} = 1/t _{RC}		240		220		195	mA	
I _{SB1}	Automatic CE Power-Down Current —TTL Inputs	Max. V _{CC} , $\overline{CE} \geq V_{IH}$ V _{IN} ≥ V _{IH} or V _{IN} ≤ V _{IL} , f = f _{MAX}		40		40		40	mA	
I _{SB2}	Automatic CE Power-Down Current —CMOS Inputs	Max. V _{CC} , $\overline{CE} \geq V_{CC} - 0.3V$, V _{IN} ≥ V _{CC} − 0.3V, or V _{IN} ≤ 0.3V, f=0	Com'l			8		8	mA	
			Com'l L			-		-	0.5	mA
			Ind'l			-		-	8	mA
			Ind'l L			-		-	0.5	mA

Notes:

- V_{IL} (min.) = -2.0V for pulse durations of less than 20 ns.
- T_A is the case temperature.

Electrical Characteristics Over the Operating Range (continued)

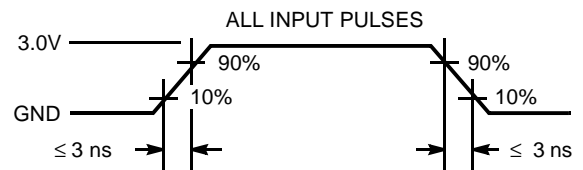
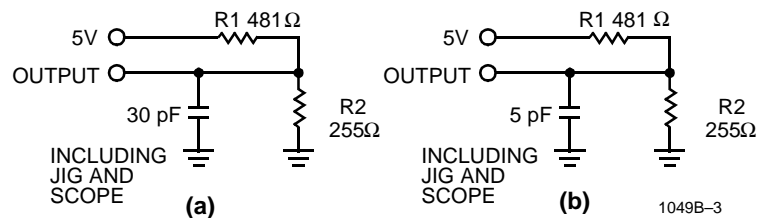
Parameter	Description	Test Conditions	7C1049B-20		7C1049B-25		Unit
			Min.	Max.	Min.	Max.	
V_{OH}	Output HIGH Voltage	$V_{CC} = \text{Min.}, I_{OH} = -4.0 \text{ mA}$	2.4		2.4		V
V_{OL}	Output LOW Voltage	$V_{CC} = \text{Min.}, I_{OL} = 8.0 \text{ mA}$		0.4		0.4	V
V_{IH}	Input HIGH Voltage		2.2	$V_{CC} + 0.3$	2.2	$V_{CC} + 0.3$	V
V_{IL}	Input LOW Voltage ^[1]		-0.3	0.8	-0.3	0.8	V
I_{IX}	Input Load Current	$GND \leq V_I \leq V_{CC}$	-1	+1	-1	+1	μA
I_{OZ}	Output Leakage Current	$GND \leq V_{OUT} \leq V_{CC}$, Output Disabled	-1	+1	-1	+1	μA
I_{CC}	V_{CC} Operating Supply Current	$V_{CC} = \text{Max.}$, $f = f_{MAX} = 1/t_{RC}$		185		180	mA
I_{SB1}	Automatic CE Power-Down Current —TTL Inputs	Max. V_{CC} , $CE \geq V_{IH}$ $V_{IN} \geq V_{IH}$ or $V_{IN} \leq V_{IL}$, $f = f_{MAX}$		40		40	mA
I_{SB2}	Automatic CE Power-Down Current —CMOS Inputs	Max. V_{CC} , $CE \geq V_{CC} - 0.3\text{V}$, $V_{IN} \geq V_{CC} - 0.3\text{V}$, or $V_{IN} \leq 0.3\text{V}$, $f = 0$	Com'I	8		8	mA
			Com'I L	0.5		0.5	mA
			Ind'I	8		8	mA
			Ind'I L	0.5		0.5	mA

Capacitance^[3]

Parameter	Description	Test Conditions	Max.	Unit
C_{IN}	Input Capacitance	$T_A = 25^\circ\text{C}$, $f = 1 \text{ MHz}$, $V_{CC} = 5.0\text{V}$	8	pF
C_{OUT}	I/O Capacitance		8	pF

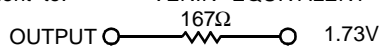
Note:

3. Tested initially and after any design or process changes that may affect these parameters.

AC Test Loads and Waveforms


1049B-4

Equivalent to: THÉVENIN EQUIVALENT



Switching Characteristics^[4] Over the Operating Range

Parameter	Description	7C1049B-12		7C1049B-15		7C1049B-17		Unit
		Min.	Max.	Min.	Max.	Min.	Max.	
READ CYCLE								
t _{power}	V _{CC} (typical) to the First Access ^[5]	1		1		1		ms
t _{RC}	Read Cycle Time	12		15		17		ns
t _{AA}	Address to Data Valid		12		15		17	ns
t _{OHA}	Data Hold from Address Change	3		3		3		ns
t _{ACE}	\overline{CE} LOW to Data Valid		12		15		17	ns
t _{DOE}	\overline{OE} LOW to Data Valid		6		7		8	ns
t _{LZOE}	\overline{OE} LOW to Low Z ^[7]	0		0		0		ns
t _{HZOE}	\overline{OE} HIGH to High Z ^[6, 7]		6		7		7	ns
t _{LZCE}	\overline{CE} LOW to Low Z ^[7]	3		3		3		ns
t _{HZCE}	\overline{CE} HIGH to High Z ^[6, 7]		6		7		7	ns
t _{PU}	\overline{CE} LOW to Power-Up	0		0		0		ns
t _{PD}	\overline{CE} HIGH to Power-Down		12		15		17	ns
WRITE CYCLE ^[8, 9]								
t _{WC}	Write Cycle Time	12		15		17		ns
t _{SCE}	\overline{CE} LOW to Write End	10		12		12		ns
t _{AW}	Address Set-Up to Write End	10		12		12		ns
t _{HA}	Address Hold from Write End	0		0		0		ns
t _{SA}	Address Set-Up to Write Start	0		0		0		ns
t _{PWE}	\overline{WE} Pulse Width	10		12		12		ns
t _{SD}	Data Set-Up to Write End	7		8		8		ns
t _{HD}	Data Hold from Write End	0		0		0		ns
t _{LZWE}	\overline{WE} HIGH to Low Z ^[7]	3		3		3		ns
t _{HZWE}	\overline{WE} LOW to High Z ^[6, 7]		6		7		8	ns

Notes:

- Test conditions assume signal transition time of 3 ns or less, timing reference levels of 1.5V, input pulse levels of 0 to 3.0V, and output loading of the specified I_{OL}/I_{OH} and 30-pF load capacitance.
- This part has a voltage regulator which steps down the voltage from 5V to 3.3V internally. t_{power} time has to be provided initially before a read/write operation is started.
- t_{HZOE} , t_{HZCE} , and t_{HZWE} are specified with a load capacitance of 5 pF as in part (b) of AC Test Loads. Transition is measured ± 500 mV from steady-state voltage.
- At any given temperature and voltage condition, t_{HZCE} is less than t_{LZCE} , t_{HZOE} is less than t_{LZOE} , and t_{HZWE} is less than t_{LZWE} for any given device.
- The internal write time of the memory is defined by the overlap of \overline{CE} LOW, and \overline{WE} LOW. \overline{CE} and \overline{WE} must be LOW to initiate a write, and the transition of either of these signals can terminate the write. The input data set-up and hold timing should be referenced to the leading edge of the signal that terminates the write.
- The minimum write cycle time for Write Cycle no. 3 (\overline{WE} controlled, \overline{OE} LOW) is the sum of t_{HZWE} and t_{SD} .

Switching Characteristics^[4] Over the Operating Range (continued)

Parameter	Description	7C1049B-20		7C1049B-25		Unit
		Min.	Max.	Min.	Max.	
READ CYCLE						
t _{power}	V _{CC} (typical) to the First Access ^[5]	1		1		1
t _{RC}	Read Cycle Time	20		25		ns
t _{AA}	Address to Data Valid		20		25	ns
t _{OHA}	Data Hold from Address Change	3		5		ns
t _{ACE}	$\overline{\text{CE}}$ LOW to Data Valid		20		25	ns
t _{DOE}	$\overline{\text{OE}}$ LOW to Data Valid		8		10	ns
t _{LZOE}	$\overline{\text{OE}}$ LOW to Low Z ^[7]	0		0		ns
t _{HZOE}	$\overline{\text{OE}}$ HIGH to High Z ^[6, 7]		8		10	ns
t _{LZCE}	$\overline{\text{CE}}$ LOW to Low Z ^[7]	3		5		ns
t _{HZCE}	$\overline{\text{CE}}$ HIGH to High Z ^[6, 7]		8		10	ns
t _{PU}	$\overline{\text{CE}}$ LOW to Power-Up	0		0		ns
t _{PD}	$\overline{\text{CE}}$ HIGH to Power-Down		20		25	ns
WRITE CYCLE ^[8]						
t _{WC}	Write Cycle Time	20		25		ns
t _{SCE}	$\overline{\text{CE}}$ LOW to Write End	13		15		ns
t _{AW}	Address Set-Up to Write End	13		15		ns
t _{HA}	Address Hold from Write End	0		0		ns
t _{SA}	Address Set-Up to Write Start	0		0		ns
t _{PWE}	$\overline{\text{WE}}$ Pulse Width	13		15		ns
t _{SD}	Data Set-Up to Write End	9		10		ns
t _{HD}	Data Hold from Write End	0		0		ns
t _{LZWE}	$\overline{\text{WE}}$ HIGH to Low Z ^[7]	3		5		ns
t _{HZWE}	$\overline{\text{WE}}$ LOW to High Z ^[6, 7]		8		10	ns

Data Retention Characteristics Over the Operating Range

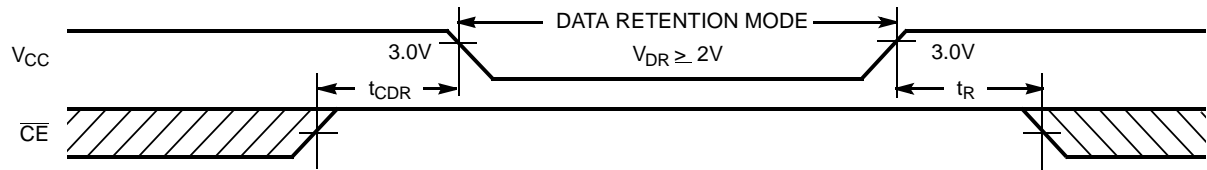
Parameter	Description			Conditions ^[11]	Min.	Max	Unit
V _{DR}	V _{CC} for Data Retention				2.0		V
I _{CCDR}	Data Retention Current	Com'I	L	V _{CC} = V _{DR} = 3.0V, CE ≥ V _{CC} − 0.3V V _{IN} ≥ V _{CC} − 0.3V or V _{IN} ≤ 0.3V		200	μA
		Ind'I				1	mA
t _{CDR} ^[3]	Chip Deselect to Data Retention Time				0		ns
t _R ^[10]	Operation Recovery Time				t _{RC}		ns

Notes:

10. $t_r \leq 3$ ns for the -12 and -15 speeds. $t_r \leq 5$ ns for the -20 ns and slower speeds.

11. No input may exceed $V_{\text{CC}} + 0.5\text{V}$.

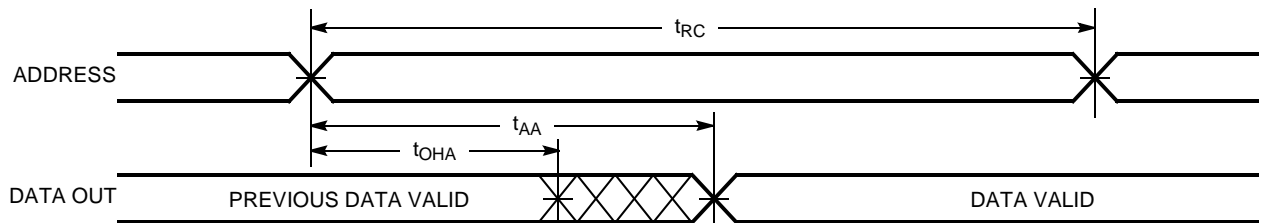
Data Retention Waveform



104B9-5

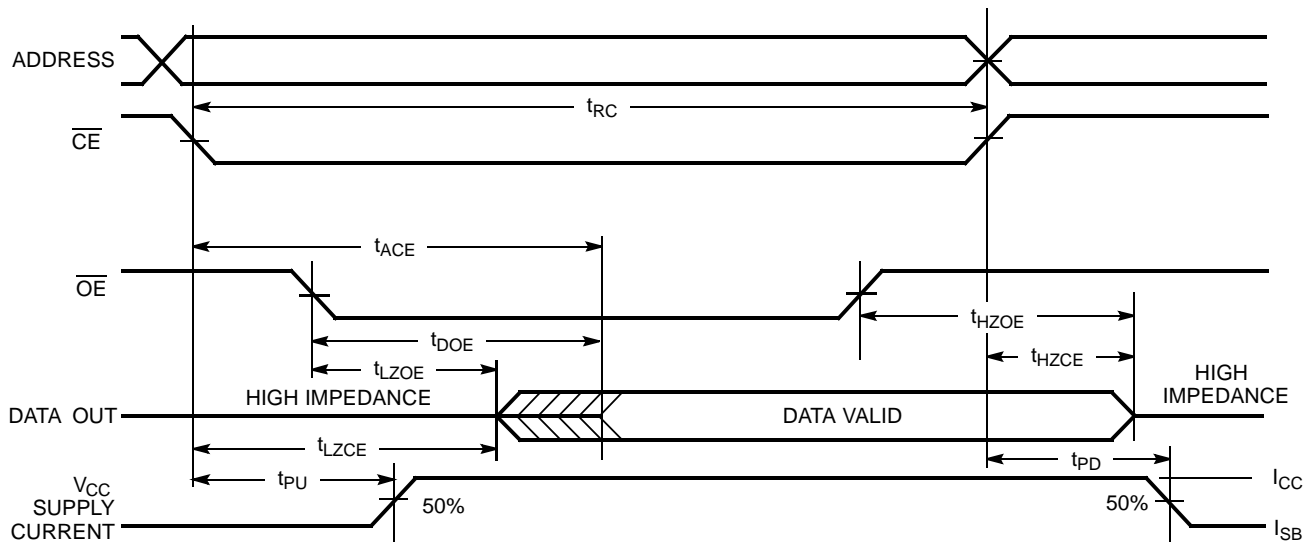
Switching Waveforms

Read Cycle No. 1^[12, 13]



104B-6

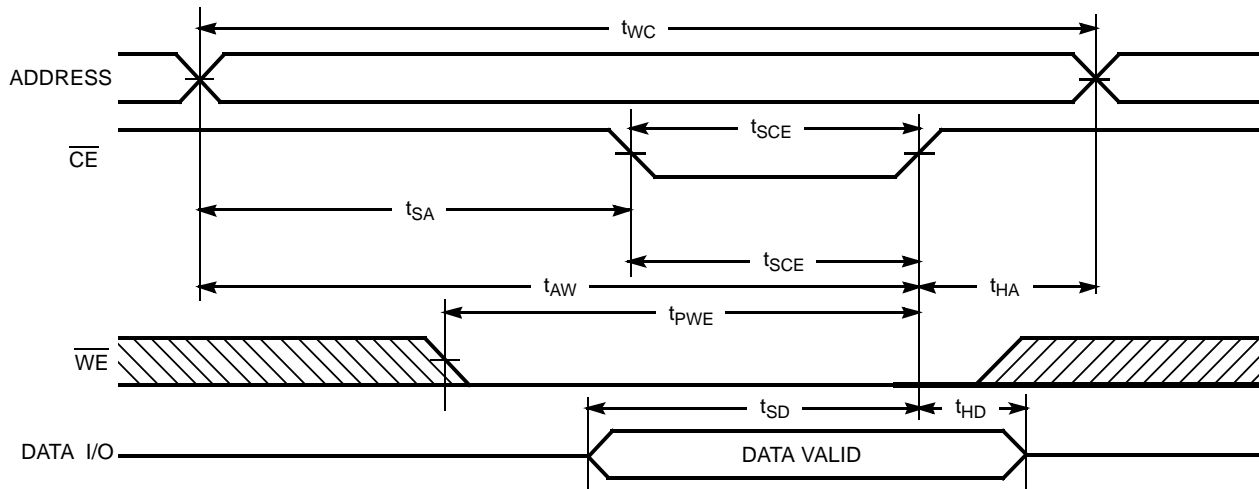
Read Cycle No. 2 (\overline{OE} Controlled)^[13, 14]



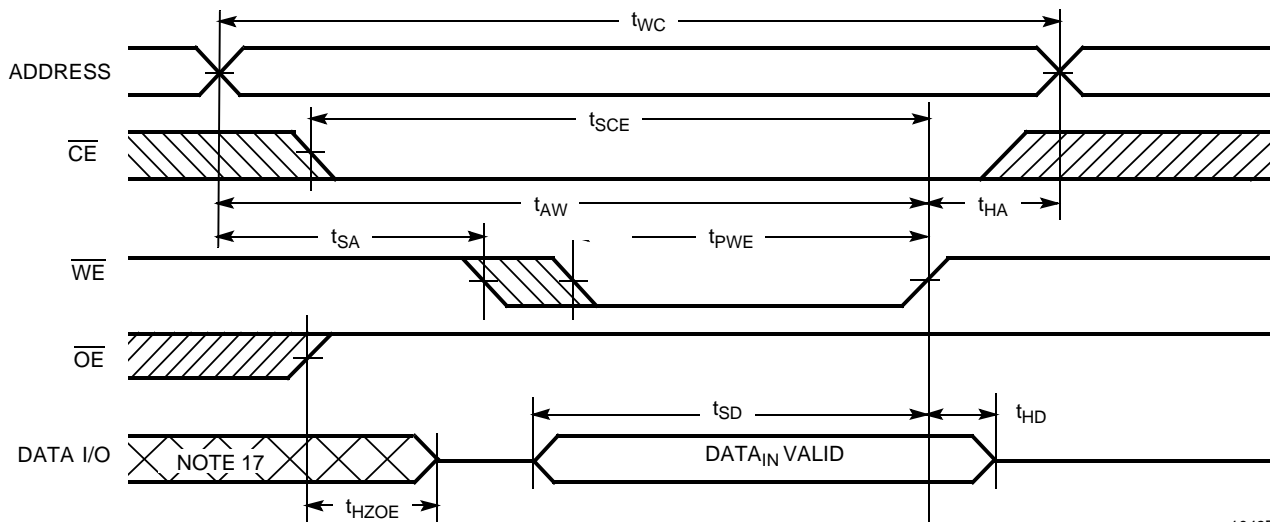
104B-7

Notes:

12. Device is continuously selected. $\overline{OE}, \overline{CE} = V_{IL}$.
13. \overline{WE} is HIGH for read cycle.
14. Address valid prior to or coincident with \overline{CE} transition LOW.

Switching Waveforms (continued)
Write Cycle No. 1 ($\overline{\text{CE}}$ Controlled)^[15, 16]


1049B-8

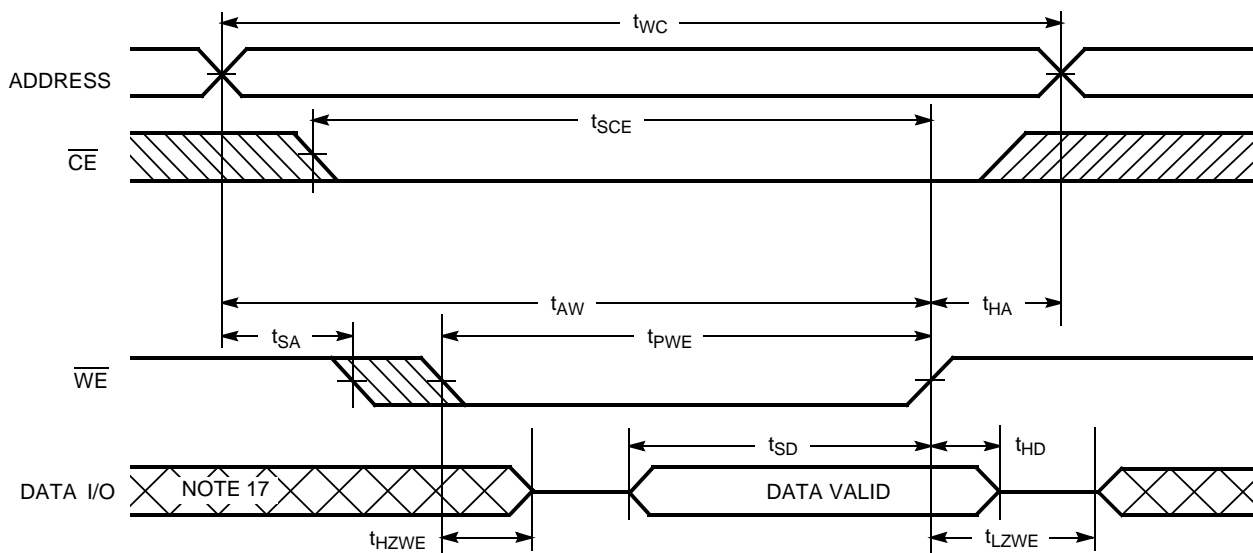
Write Cycle No. 2 ($\overline{\text{WE}}$ Controlled, $\overline{\text{OE}}$ HIGH During Write)^[15, 16]


1049B-9

Notes:

15. Data I/O is high impedance if $\overline{\text{OE}} = V_{IH}$.
16. If $\overline{\text{CE}}$ goes HIGH simultaneously with $\overline{\text{WE}}$ going HIGH, the output remains in a high-impedance state.
17. During this period the I/Os are in the output state and input signals should not be applied.

Switching Waveforms (continued)

Write Cycle No. 3 ($\overline{\text{WE}}$ Controlled, $\overline{\text{OE}}$ LOW)^[16]


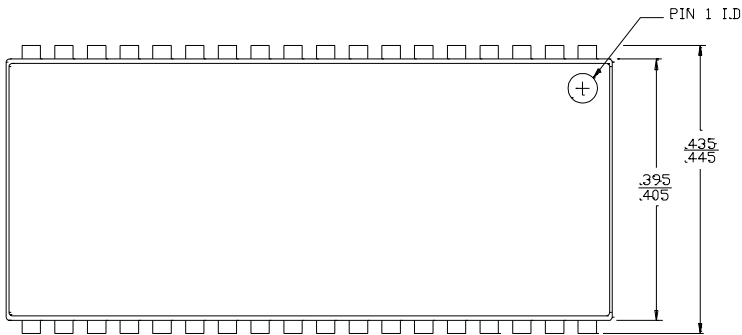
1049B-10

Ordering Information

Speed (ns)	Ordering Code	Package Name	Package Type	Operating Range
12	CY7C1049B-12VC	V36	36-Lead (400-Mil) Molded SOJ	Commercial
15	CY7C1049B-15VC	V36	36-Lead (400-Mil) Molded SOJ	
	CY7C1049B-15VI	V36	36-Lead (400-Mil) Molded SOJ	Industrial
17	CY7C1049B-17VC	V36	36-Lead (400-Mil) Molded SOJ	Commercial
	CY7C1049BL-17VC	V36	36-Lead (400-Mil) Molded SOJ	
	CY7C1049B-17VI	V36	36-Lead (400-Mil) Molded SOJ	Industrial
20	CY7C1049B-20VC	V36	36-Lead (400-Mil) Molded SOJ	Commercial
	CY7C1049BL-20VC	V36	36-Lead (400-Mil) Molded SOJ	
	CY7C1049B-20VI	V36	36-Lead (400-Mil) Molded SOJ	Industrial
	CY7C1049BL-20VI	V36	36-Lead (400-Mil) Molded SOJ	
25	CY7C1049B-25VC	V36	36-Lead (400-Mil) Molded SOJ	Commercial
	CY7C1049BL-25VC	V36	36-Lead (400-Mil) Molded SOJ	
	CY7C1049B-25VI	V36	36-Lead (400-Mil) Molded SOJ	Industrial
	CY7C1049BL-25VI	V36	36-Lead (400-Mil) Molded SOJ	

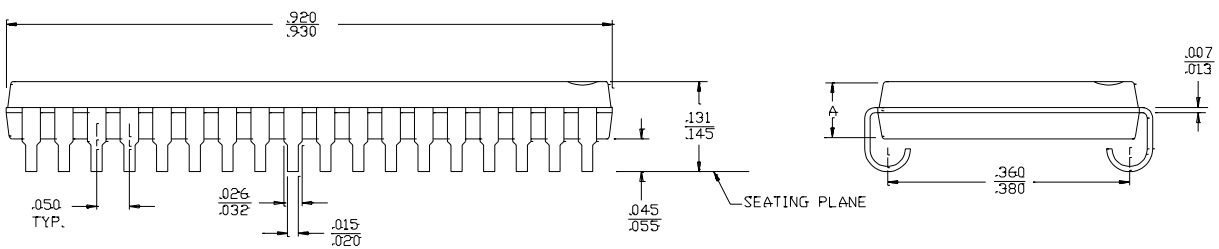
Package Diagram

36-Lead (400-Mil) Molded SOJ V36



DIMENSIONS IN INCHES MIN.
MAX.

DIM. A	
ANAM	CSPI
.086	.095
.090	.115



51-85090-B

Document Title: CY7C1049B 512K x 8 Static RAM
Document Number: 38-05169

REV.	ECN NO.	Issue Date	Orig. of Change	Description of Change
**	110209	12/02/01	SZV	Change from Spec number: 38-00937 to 38-05169